

# UCC3952-1, UCC3952-2, UCC3952-3, UCC3952-4 Single-Cell Lithium-Ion Battery Protection IC

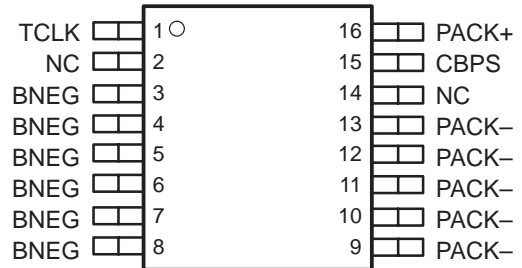
SLUS400B– JULY 2000

- Protects Sensitive Lithium-Ion Cells From Overcharging and Over-Discharging
- Dedicated for One-Cell Applications
- Integrated Low-Impedance MOSFET Switch and Sense Resistor
- Precision Trimmed Overcharge and Overdischarge Voltage Limits
- Extremely Low Power Drain
- 3-A Current Capacity
- Overcurrent and Short-Circuit Protection
- Reverse Charger Protection
- Thermal Protection

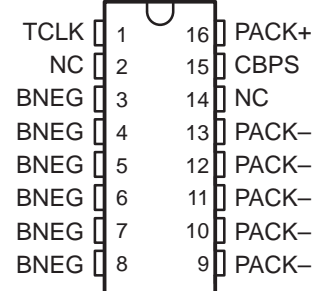
## description

The UCC3952 is a monolithic BiCMOS lithium-ion battery protection circuit designed to enhance the useful operating life of a one-cell rechargeable battery pack. Cell protection features include internally trimmed charge and discharge voltage limits, discharge current limit with a delayed shutdown, and an ultra-low-current sleep mode state when the cell is discharged. Additional features include an on-chip MOSFET for reduced external component count and a charge pump for reduced power losses while charging or discharging a low-cell-voltage battery pack. This protection circuit requires one external capacitor and can operate and safely shut down in a short circuit condition.

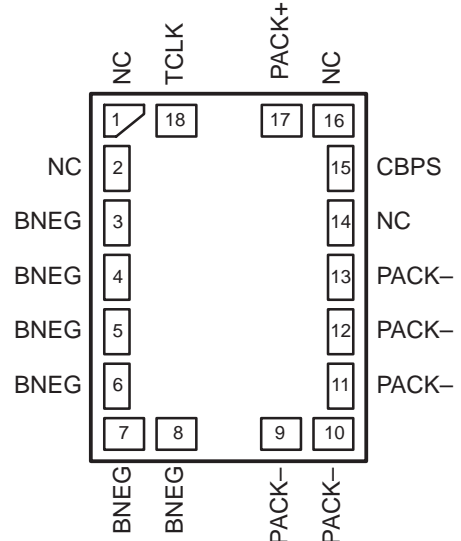
PW PACKAGE  
(TOP VIEW)



DP PACKAGE  
(TOP VIEW)



GSH PACKAGE  
(TOP VIEW)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

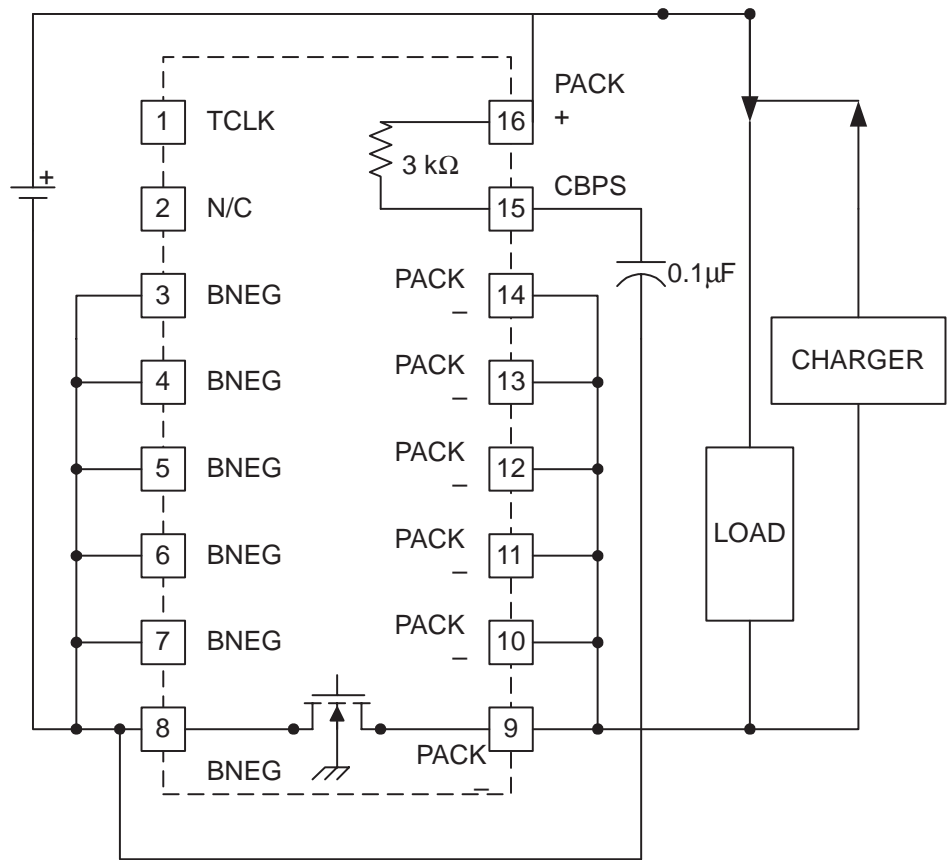
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application diagram



AVAILABLE OPTIONS

T <sub>A</sub>	PACKAGES		
	TSSOP-16 (PW)	SOIC-16 (DP)	BCC-18 (GSH)†
-25°C to 70 °C	UCC3952-1PW	UCC3952-1DP	UCC3952-1GSH
	UCC3952-2PW	UCC3952-2DP	UCC3952-2GSH
	UCC3952-3PW	UCC3952-3DP	UCC3952-3GSH
	UCC3952-4PW	UCC3952-4DP	UCC3952-4GSH

† Contact your local TI sales office for availability.

# UCC3952-1, UCC3952-2, UCC3952-3, UCC3952-4 Single-Cell Lithium-Ion Battery Protection IC

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## absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>

Supply voltage (PACK+ to BNEG) .....	7 V
Maximum forward voltage (PACK+ to PACK–) .....	16 V
Maximum reverse voltage (where PACK+ to BNEG = 5V) .....	–8 V
Maximum cell continuous charge current .....	3 A
Junction temperature, T <sub>J</sub> .....	–55°C to 150°C
Storage Temperature range, T <sub>stg</sub> .....	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: Currents are positive into, negative out of the specified terminal. Consult Packaging Section of Data Book for thermal limitations and considerations of packages. All voltages are referenced to GND.

## electrical characteristics, T<sub>A</sub> = –20°C to 70°C, all voltages are with respect to BNEG (unless otherwise stated)

### state transition threshold

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNITS
V <sub>(OV)</sub>	Normal to overcharge voltage	UCC3952–1		4.15	4.20	4.25	V
		UCC3952–2		4.20	4.25	4.30	
		UCC3952–3		4.25	4.30	4.35	
		UCC3952–4		4.30	4.35	4.40	
V <sub>(OVR)</sub>	Overcharge to normal recovery voltage	UCC3952–1		3.85	3.90	3.95	V
		UCC3952–2		3.90	3.95	4.00	
		UCC3952–3		3.95	4.00	4.05	
		UCC3952–4		4.00	4.05	4.10	
V <sub>(UV)</sub>	Normal to undercharge			2.25	2.35	2.45	V
V <sub>(UVR)</sub>	Undercharge to normal recovery			2.55	2.65	2.75	V
t <sub>d(OV)</sub>	Overcharge delay time			10	25	40	ms

### short circuit protection

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNITS
I <sub>(THLD)</sub>	Discharge current limit		PACK+ = 3.7 mV	3.0		6.0	A
t <sub>d(DLY)</sub>	Discharge current delay		PACK+ = 3.7 mV, I <sub>I</sub> = 6 A	1		3.0	ms
R <sub>(RESET)</sub>	Discharge current reset resistance		PACK+ = 3.7 mV	7.5			mΩ

### bias

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNITS
I <sub>DD</sub>	Supply current		V <sub>(UV)</sub> < V <sub>(PACK)</sub> < V <sub>(OV)</sub>		5	8	μA
I <sub>DD(OV)</sub>	Operating supply current in overvoltage		V <sub>(OV)</sub> < V <sub>(PACK)</sub>		11	24	μA
I <sub>(SD)</sub>	Shutdown current		V <sub>(PACK)</sub> = 2.0 V			2.5	μA
V <sub>(min)</sub>	Minimum cell voltage when all circuits are fully functional					1.7	V



# UCC3952-1, UCC3952-2, UCC3952-3, UCC3952-4

## Single-Cell Lithium-Ion Battery Protection IC

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electrical characteristics,  $T_A = -20^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ , all voltages are with respect to BNEG (unless otherwise stated) (continued)

### FET switch

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNITS
$V_{(\text{PACK}-)}$	Voltage at PACK–	PACK+ > $V_{\text{OV}}$ , $I_{(\text{SWITCH})} = 1\text{ mA to } 2\text{ A}$ , Battery overcharged state switch permits discharge current only.		100	400	mV
		PACK+ = 2.5V, $I_{(\text{SWITCH})} = -1\text{ mA to } -2\text{ A}$ , Battery overdischarged state switch permits charge current only.	–600	–100		mV
$R_{\text{ON}}$	Series resistance of the device	PACK+ = 2.5 V, In normal mode (when not in OV or UV). This value includes package and bondwire resistance.		50	75	$\Omega$

### thermal shutdown

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNITS
$T_{(\text{SD})}$	Thermal shutdown temperature (see Note 2)			135		$^{\circ}\text{C}$

NOTE 2: This parameter is ensured by design and is not production tested.

## detailed description

### pin descriptions

#### BNEG

Connect the negative terminal of the battery to this pin.

#### PACK+

Connect to the positive terminal of the battery. This pin is available to the user.

#### CBPS

This power supply bypass pin is connected to PACK+ through an internal 3-k $\Omega$  resistor. An external 0.1- $\mu\text{F}$  capacitor must be connected between this pin and BNEG.

#### PACK–

The negative terminal of the battery pack (negative terminal available to the user). The internal FET switch connects this terminal to the BNEG terminal to give the battery pack user appropriate access to the battery. In an overcharged state, only discharge current is permitted. In an overdischarged state, only charge current is permitted.

#### SUB (DP Package Only)

Do not connect. These pins must be electrically isolated from all other pins. The SUB pins may be soldered to an isolated copper pad for heatsinking. However, most applications do not require heatsinking.

#### TCLK

Production test mode pin. This pin is used to provide a high-frequency clock to the IC during production testing. In an application, this pin is left unconnected or tied to BNEG.



[illegible]

## battery voltage monitoring

When the cell voltage falls below the undervoltage threshold for two consecutive samples, the IC disconnects the load from the battery pack and enters a super-low-power mode. The pack remains in this state until it detects the application of a charger, at which point charging is enabled. The requirement of two consecutive readings below the undervoltage threshold filters out momentary drops in cell voltage due to load transients, preventing nuisance trips.

If the cell voltage exceeds the overvoltage threshold for 1 second, charging is disabled; however, discharge current is still allowed. This feature of the IC is explained further in the *controlled charge/discharge mode* section of this document.

# UCC3952-1, UCC3952-2, UCC3952-3, UCC3952-4 Single-Cell Lithium-Ion Battery Protection IC

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## APPLICATION INFORMATION

### overcurrent monitoring and protection

Discharge current is continuously monitored via an internal sense resistor. In the event of excessive current, an overcurrent condition is declared if the high current (over 3 A) persists for over 1 ms. This delay allows for charging of the system bypass capacitors without tripping the overcurrent protection. A 0.1- $\mu$ F capacitor on the CBPS pin provides momentary holdup for the IC to assure proper operation in the event that a hard short suddenly pulls the cell voltage below the minimum operating voltage.

Once an overcurrent condition has been declared, the internal MOSFET turns off. The only way to return the pack to normal operation is to remove the load by unplugging the pack from the system. The overcurrent is reset when an internal pulldown brings PACK– to within 50 mV of BNEG. At this point, the pack returns to its normal state of operation.

### controlled charge/discharge mode

When the chip senses an overvoltage condition, it prevents any additional charging, but allows discharge. This is accomplished by activating a linear control loop, which controls the gate of the MOSFET based on the differential voltage across its drain-to-source terminals. The linear loop attempts to regulate the differential voltage across the MOSFET to 100 mV. When a light load is applied to the part, the loop adjusts the impedance of the MOSFET to maintain 100 mV across it. As the load increases, the impedance of the MOSFET is decreased to maintain the 100-mV control. At heavy loads (still below the overcurrent limit), the loop does not maintain regulation and drives the gate of the MOSFET to the battery voltage (not the charge-pump output voltage). The MOSFET  $R_{DS(on)}$  in the overvoltage state is higher than  $R_{DS(on)}$  during normal operation. The voltage drop (and associated power loss) across the internal MOSFET in this mode of operation is still significantly lower than the typical solution of two external back-to-back MOSFETs, where the body diode is conducting.

When the chip senses an undervoltage condition, it disconnects the load from the battery pack and shuts itself down to minimize current drain from the battery. Several circuits remain powered and detect placement of the battery pack into a charger. Once the charger presence is detected, the linear loop is activated and the chip allows charging current into the battery. This linear control mode of operation is in effect until the battery voltage reaches a level of  $V_{UVR}$ , at which time normal operation is resumed.



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